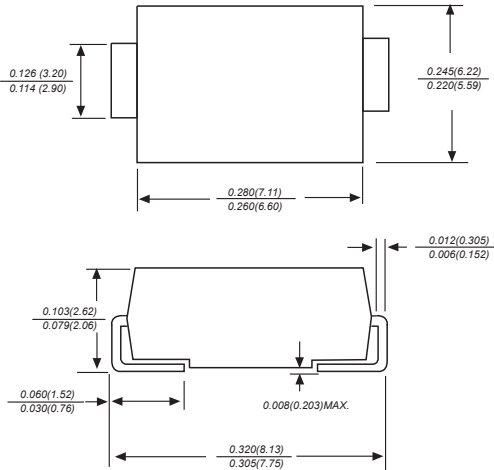


DO-214AB/SMC



Dimensions in inches and (millimeters)

FEATURES

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ For surface mounted applications
- ◆ Low reverse leakage
- ◆ Built-in strain relief, ideal for automated placement
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed: 250°C/10 seconds at terminals
- ◆ Glass passivated chip junction

MECHANICAL DATA

Case: JEDEC DO-214AB molded plastic body over passivated chip

Terminals: Solder plated, solderable per MIL-STD-750, Method 2026

Polarity: Color band denotes cathode end

Mounting Position: Any

Weight: 0.007 ounce, 0.25grams

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

	SYMBOLS	ES5A	ES5B	ES5C	ES5D	ES5E	ES5G	ES5J	UNITS
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	150	200	300	400	600	VOLTS
Maximum RMS voltage	V _{RMS}	35	70	105	140	210	280	420	VOLTS
Maximum DC blocking voltage	V _{DC}	50	100	150	200	300	400	600	VOLTS
Maximum average forward rectified current at T _L =75°C	I _(AV)	5.0							Amps
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	150.0							Amps
Maximum instantaneous forward voltage at 5.0A	V _F	0.95				1.25		1.7	Volts
Maximum DC reverse current T _A =25°C at rated DC blocking voltage T _A =100°C	I _R	5.0 100.0							μA
Maximum reverse recovery time (NOTE 1)	t _{rr}	35							ns
Typical junction capacitance (NOTE 2)	C _J	58.0							pF
Typical thermal resistance (NOTE 3)	R _{θJA}	47.0							°C/W
Operating junction and storage temperature range	T _J , T _{STG}	-65 to +150							°C

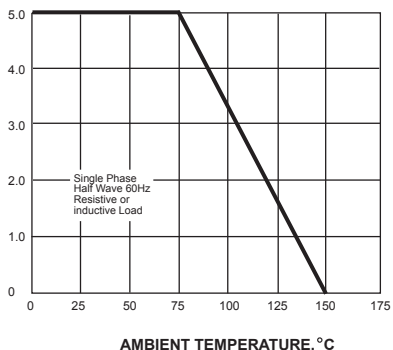
Note: 1. Reverse recovery condition $I_F=0.5\text{A}$, $I_R=1.0\text{A}$, $I_{rr}=0.25\text{A}$

2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.

3. P.C.B. mounted with 0.2x0.2" (5.0x5.0mm) copper pad areas

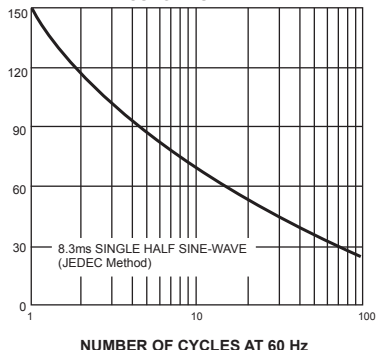
AVERAGE FORWARD RECTIFIED CURRENT,
AMPERES

FIG. 1- FORWARD CURRENT DERATING CURVE



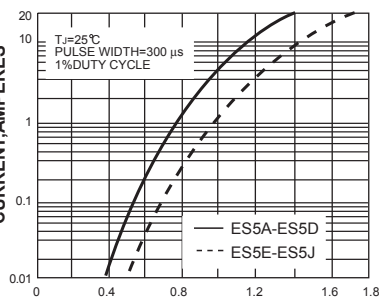
PEAK FORWARD SURGE CURRENT,
AMPERES

FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT



INSTANTANEOUS FORWARD CURRENT, AMPERES

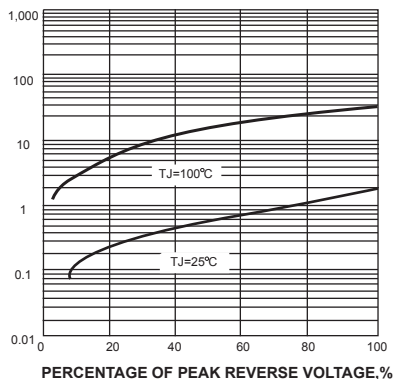
FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS



INSTANTANEOUS FORWARD VOLTAGE,
VOLTS

INSTANTANEOUS REVERSE CURRENT,
MICROAMPERES

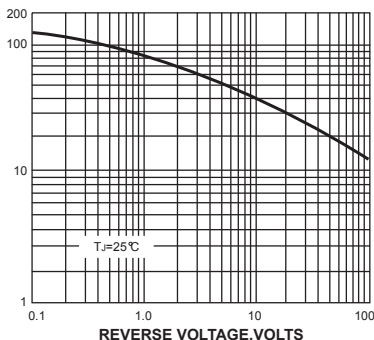
FIG. 4-TYPICAL REVERSE CHARACTERISTICS



PERCENTAGE OF PEAK REVERSE VOLTAGE, %

JUNCTION CAPACITANCE, pF

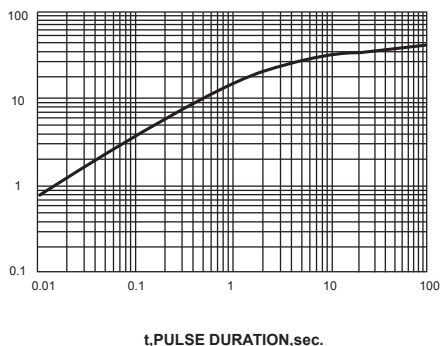
FIG. 5-TYPICAL JUNCTION CAPACITANCE



REVERSE VOLTAGE, VOLTS

TRANSIENT THERMAL IMPEDANCE,
°C/W

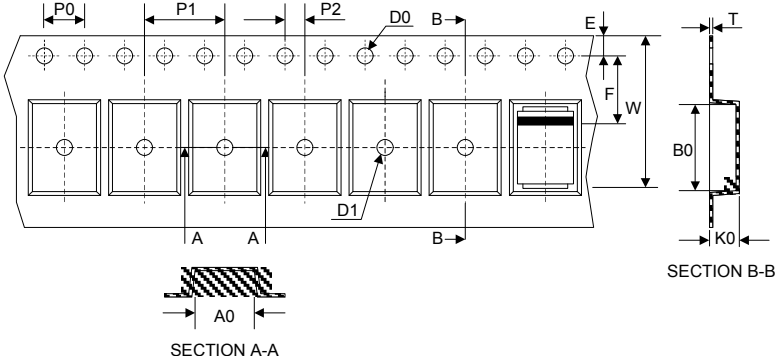
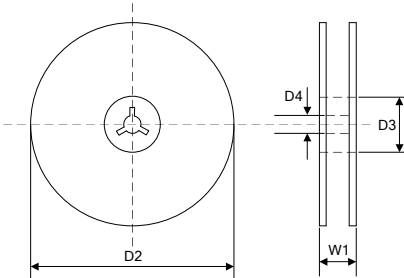
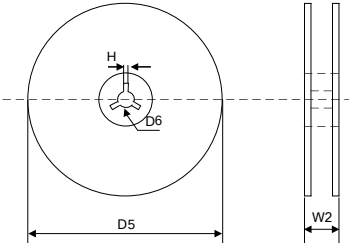
FIG. 6-TYPICAL TRANSIENT THERMAL IMPEDANCE



t, PULSE DURATION, sec.



Packaging

Tape	Tape		Symbol	Dimension (mm)
			W	16.00±0.20
			P0	4.00±0.10
			P1	8.00±0.10
			P2	2.00±0.10
			D0	Φ1.5±0.10
			D1	Φ1.5±0.10
			E	1.75±0.10
			F	7.50±0.10
			A0	6.27±0.10
			B0	8.30±0.10
7" Reel			K0	3.15±0.15
			T	0.30±0.05
			D2	Φ178.0±2.0
			D3	Φ50.0Min.
			D4	Φ13.0±0.5
			W1	20.0±2.0
13" Reel			Quantity: 500PCS	
			D5	Φ330.0±2.0
			D6	Φ13.5±0.5
			H	2.5±1.0
			W2	20.0±2.0
			Quantity: 3000PCS	